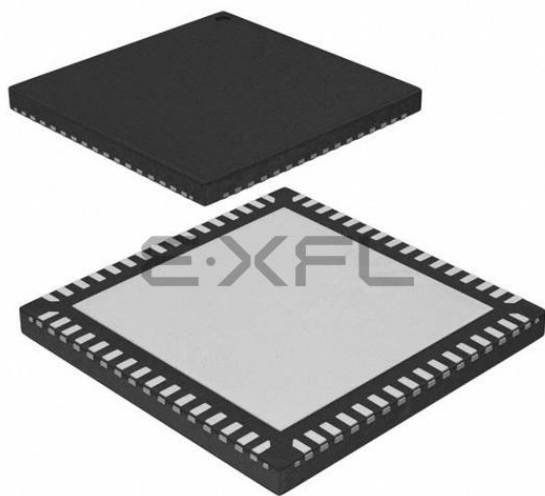




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Details

Product Status	Active
Core Processor	ARM® Cortex®-M0+
Core Size	32-Bit Single-Core
Speed	48MHz
Connectivity	I ² C, LINbus, SPI, UART/USART, USB
Peripherals	Brown-out Detect/Reset, DMA, I ² S, POR, PWM, WDT
Number of I/O	52
Program Memory Size	128KB (128K x 8)
Program Memory Type	FLASH
EEPROM Size	-
RAM Size	16K x 8
Voltage - Supply (Vcc/Vdd)	1.62V ~ 3.6V
Data Converters	A/D 20x12b; D/A 1x10b
Oscillator Type	Internal
Operating Temperature	-40°C ~ 125°C (TA)
Mounting Type	Surface Mount
Package / Case	64-VFQFN Exposed Pad
Supplier Device Package	64-QFN (9x9)
Purchase URL	https://www.e-xfl.com/product-detail/microchip-technology/atsamd21j17a-mf

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Value	Name	Description
10	MEDIUM	Sensitive Latency
11	HIGH	Critical Latency

If a master is configured with QoS level 0x00 or 0x01 there will be minimum one cycle latency for the RAM access.

The priority order for concurrent accesses are decided by two factors. First the QoS level for the master and then a static priority given by table nn-mm (table: SRAM port connection) where the lowest port ID has the highest static priority.

The MTB has fixed QoS level 3 and the DSU has fixed QoS level 1.

The CPU QoS level can be written/read at address 0x41007110, bits [1:0]. Its reset value is 0x0.

Refer to different master QOSCTRL registers for configuring QoS for the other masters (USB, DMAC).

11.5 AHB-APB Bridge

The AHB-APB bridge is an AHB slave, providing an interface between the high-speed AHB domain and the low-power APB domain. It is used to provide access to the programmable control registers of peripherals (see [Product Mapping](#)).

AHB-APB bridge is based on AMBA APB Protocol Specification V2.0 (ref. as APB4) including:

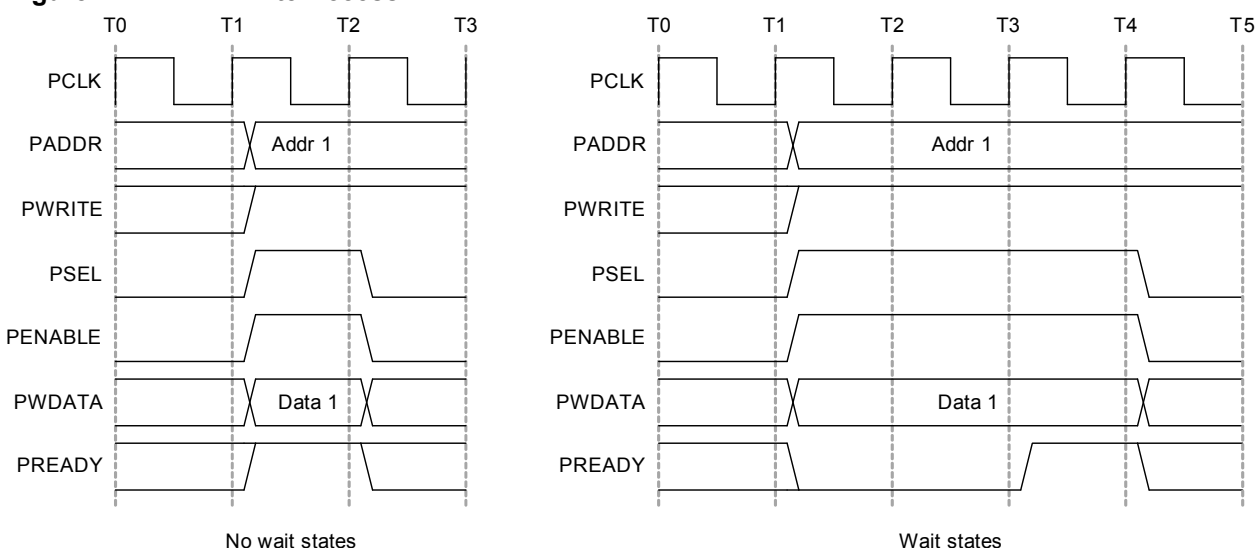
- Wait state support
- Error reporting
- Transaction protection
- Sparse data transfer (byte, half-word and word)

Additional enhancements:

- Address and data cycles merged into a single cycle
- Sparse data transfer also apply to read access

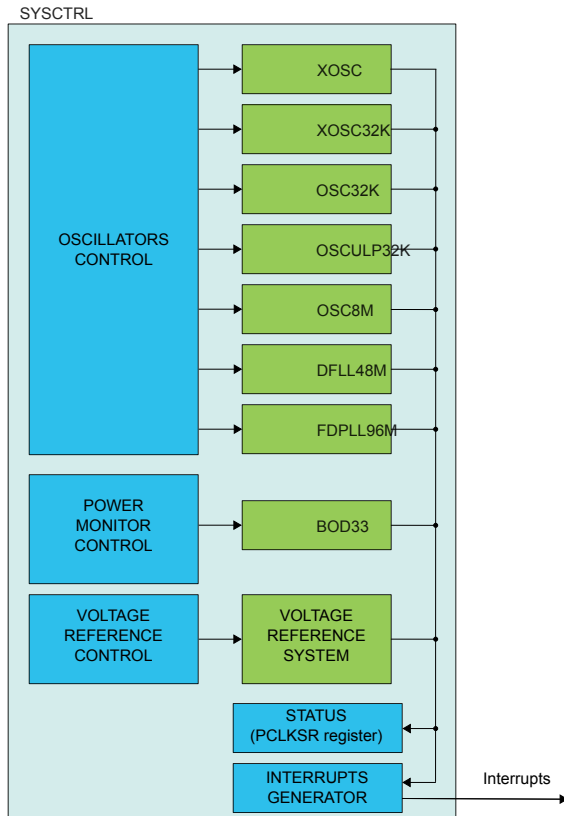
to operate the AHB-APB bridge, the clock (CLK_HPBr_AHB) must be enabled. See *PM – Power Manager* for details.

Figure 11-1. APB Write Access.



17.3 Block Diagram

Figure 17-1. SYSCTRL Block Diagram



17.4 Signal Description

Signal Name	Types	Description
XIN	Analog Input	Multipurpose Crystal Oscillator or external clock generator input
XOUT	Analog Output	External Multipurpose Crystal Oscillator output
XIN32	Analog Input	32kHz Crystal Oscillator or external clock generator input
XOUT32	Analog Output	32kHz Crystal Oscillator output

The I/O lines are automatically selected when XOSC or XOSC32K are enabled. Refer to *Oscillator Pinout*.

Related Links

[I/O Multiplexing and Considerations](#)

17.5 Product Dependencies

In order to use this peripheral, other parts of the system must be configured correctly, as described below.

32-bit ARM-Based Microcontrollers

Table 19-1. MODE0 - Mode Register Summary

Offset	Name	Bit Pos.								
0x00	CTRL	7:0	MATCHCLR				MODE[1:0]		ENABLE	SWRST
0x01		15:8					PRESCALER[3:0]			
0x02	READREQ	7:0					ADDR[5:0]			
0x03		15:8	RREQ	RCONT						
0x04	EVCTRL	7:0	PEREO7	PEREO6	PEREO5	PEREO4	PEREO3	PEREO2	PEREO1	PEREO0
0x05		15:8	OVFEO							CMPEO0
0x06	INTENCLR	7:0	OVF	SYNCRDY						CMP0
0x07	INTENSET	7:0	OVF	SYNCRDY						CMP0
0x08	INTFLAG	7:0	OVF	SYNCRDY						CMP0
0x09	Reserved									
0x0A	STATUS	7:0	SYNCBUSY							
0x0B	DBGCTRL	7:0								DBGRUN
0x0C	FREQCORR	7:0	SIGN				VALUE[6:0]			
0x0D ... 0x0F	Reserved									
0x10	COUNT	7:0					COUNT[7:0]			
0x11		15:8					COUNT[15:8]			
0x12		23:16					COUNT[23:16]			
0x13		31:24					COUNT[31:24]			
0x14 ... 0x17	Reserved									
0x18	COMP0	7:0					COMP[7:0]			
0x19		15:8					COMP[15:8]			
0x1A		23:16					COMP[23:16]			
0x1B		31:24					COMP[31:24]			

Table 19-2. MODE1 - Mode Register Summary

Offset	Name	Bit Pos.								
0x00	CTRL	7:0					MODE[1:0]		ENABLE	SWRST
0x01		15:8					PRESCALER[3:0]			
0x02	READREQ	7:0					ADDR[5:0]			
0x03		15:8	RREQ	RCONT						
0x04	EVCTRL	7:0	PEREO7	PEREO6	PEREO5	PEREO4	PEREO3	PEREO2	PEREO1	PEREO0
0x05		15:8	OVFEO						CMPEO1	CMPEO0
0x06	INTENCLR	7:0	OVF	SYNCRDY					CMP1	CMP0
0x07	INTENSET	7:0	OVF	SYNCRDY					CMP1	CMP0
0x08	INTFLAG	7:0	OVF	SYNCRDY					CMP1	CMP0
0x09	Reserved									
0x0A	STATUS	7:0	SYNCBUSY							
0x0B	DBGCTRL	7:0								DBGRUN
0x0C	FREQCORR	7:0	SIGN				VALUE[6:0]			

32-bit ARM-Based Microcontrollers

Offset	Name	Bit Pos.								
0x10	INTFLAG	7:0	EXTINT7	EXTINT6	EXTINT5	EXTINT4	EXTINT3	EXTINT2	EXTINT1	EXTINT0
0x11		15:8	EXTINT15	EXTINT14	EXTINT13	EXTINT12	EXTINT11	EXTINT10	EXTINT9	EXTINT8
0x12		23:16							EXTINT17	EXTINT16
0x13		31:24								
0x14	WAKEUP	7:0	WAKEUPEN7	WAKEUPEN6	WAKEUPEN5	WAKEUPEN4	WAKEUPEN3	WAKEUPEN2	WAKEUPEN1	WAKEUPEN0
0x15		15:8	WAKEUPEN15	WAKEUPEN14	WAKEUPEN13	WAKEUPEN12	WAKEUPEN11	WAKEUPEN10	WAKEUPEN9	WAKEUPEN8
0x16		23:16							WAKEUPEN17	WAKEUPEN16
0x17		31:24								
0x18	CONFIG0	7:0	FILTEN1	SENSE1[2:0]			FILTEN0	SENSE0[2:0]		
0x19		15:8	FILTEN3	SENSE3[2:0]			FILTEN2	SENSE2[2:0]		
0x1A		23:16	FILTEN5	SENSE5[2:0]			FILTEN4	SENSE4[2:0]		
0x1B		31:24	FILTEN7	SENSE7[2:0]			FILTEN6	SENSE6[2:0]		
0x1C	CONFIG1	7:0	FILTEN9	SENSE9[2:0]			FILTEN8	SENSE8[2:0]		
0x1D		15:8	FILTEN11	SENSE11[2:0]			FILTEN10	SENSE10[2:0]		
0x1E		23:16	FILTEN13	SENSE13[2:0]			FILTEN12	SENSE12[2:0]		
0x1F		31:24	FILTEN15	SENSE15[2:0]			FILTEN14	SENSE14[2:0]		
0x20	CONFIG2	7:0	FILTEN25	SENSE25[2:0]			FILTEN24	SENSE24[2:0]		
0x21		15:8	FILTEN27	SENSE27[2:0]			FILTEN26	SENSE26[2:0]		
0x22		23:16	FILTEN29	SENSE29[2:0]			FILTEN28	SENSE28[2:0]		
0x23		31:24	FILTEN31	SENSE31[2:0]			FILTEN30	SENSE30[2:0]		

21.8 Register Description

Registers can be 8, 16, or 32 bits wide. Atomic 8-, 16-, and 32-bit accesses are supported. In addition, the 8-bit quarters and 16-bit halves of a 32-bit register, and the 8-bit halves of a 16-bit register can be accessed directly.

Some registers require synchronization when read and/or written. Synchronization is denoted by the "Read-Synchronized" and/or "Write-Synchronized" property in each individual register description.

Some registers are enable-protected, meaning they can only be written when the module is disabled. Enable-protection is denoted by the "Enable-Protected" property in each individual register description.

21.8.1 Control

Name: CTRL

Offset: 0x00

Reset: 0x00

Property: Write-Protected, Write-Synchronized

Bit	7	6	5	4	3	2	1	0
							ENABLE	SWRST
Access							R/W	R/W
Reset							0	0

28.10 Register Description - I²C Master

Registers can be 8, 16, or 32 bits wide. Atomic 8-, 16- and 32-bit accesses are supported. In addition, the 8-bit quarters and 16-bit halves of a 32-bit register, and the 8-bit halves of a 16-bit register can be accessed directly.

Some registers are optionally write-protected by the Peripheral Access Controller (PAC). Optional PAC write-protection is denoted by the "PAC Write-Protection" property in each individual register description. For details, refer to [Register Access Protection](#).

Some registers are synchronized when read and/or written. Synchronization is denoted by the "Write-Synchronized" or the "Read-Synchronized" property in each individual register description. For details, refer to [Synchronization](#).

Some registers are enable-protected, meaning they can only be written when the peripheral is disabled. Enable-protection is denoted by the "Enable-Protected" property in each individual register description.

28.10.1 Control A

Name: CTRLA

Offset: 0x00

Reset: 0x00000000

Property: PAC Write-Protection, Enable-Protected, Write-Synchronized

Bit	31	30	29	28	27	26	25	24
		LOWTOUT	INACTOUT[1:0]		SCLSM		SPEED[1:0]	
Access		R/W	R/W	R/W	R/W		R/W	R/W
Reset		0	0	0	0		0	0
Bit	23	22	21	20	19	18	17	16
	SEXTTOEN	MEXTTOEN	SDAHOLD[1:0]					PINOUT
Access	R/W	R/W	R/W	R/W				R/W
Reset	0	0	0	0				0
Bit	15	14	13	12	11	10	9	8
Access								
Reset								
Bit	7	6	5	4	3	2	1	0
	RUNSTDBY			MODE[2:0]			ENABLE	SWRST
Access	R/W			R/W	R/W	R/W	R/W	R/W
Reset	0			0	0	0	0	0

Bit 30 – LOWTOUT: SCL Low Time-Out

This bit enables the SCL low time-out. If SCL is held low for 25ms-35ms, the master will release its clock hold, if enabled, and complete the current transaction. A stop condition will automatically be transmitted.

INTFLAG.SB or INTFLAG.MB will be set as normal, but the clock hold will be released. The STATUS.LOWTOUT and STATUS.BUSERR status bits will be set.

This bit is not synchronized.

29.9.7 Serializer n Control

Name: SERCTRLn

Offset: 0x20 + n*0x04 [n=0..1]

Reset: 0x00000000

Property: Enable-Protected, PAC Write-Protection

Bit	31	30	29	28	27	26	25	24
						RXLOOP	DMA	MONO
Access						R/W	R/W	R/W
Reset						0	0	0

Bit	23	22	21	20	19	18	17	16
	SLOTDIS8	SLOTDIS7	SLOTDIS6	SLOTDIS5	SLOTDIS4	SLOTDIS3	SLOTDIS1	SLOTDIS0
Access	R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W
Reset	0	0	0	0	0	0	0	0

Bit	15	14	13	12	11	10	9	8
	BITREV	EXTEND[1:0]		WORDADJ		DATASIZE[2:0]		
Access	R/W	R/W	R/W	R/W		R/W	R/W	R/W
Reset	0	0	0	0		0	0	0

Bit	7	6	5	4	3	2	1	0
	SLOTADJ		CLKSEL	TXSAME	TXDEFAULT[1:0]		SERMODE[1:0]	
Access	R/W		R/W	R/W	R/W	R/W	R/W	R/W
Reset	0		0	0	0	0	0	0

Bit 26 – RXLOOP: Loop-back Test Mode

This bit enables a loop-back test mode:

Value	Description
0	Each Receiver uses its SDn pin as input (default mode).
1	Receiver uses as input the transmitter output of the other Serializer in the pair: e.g. SD1 for SD0 or SD0 for SD1.

Bit 25 – DMA: Single or Multiple DMA Channels

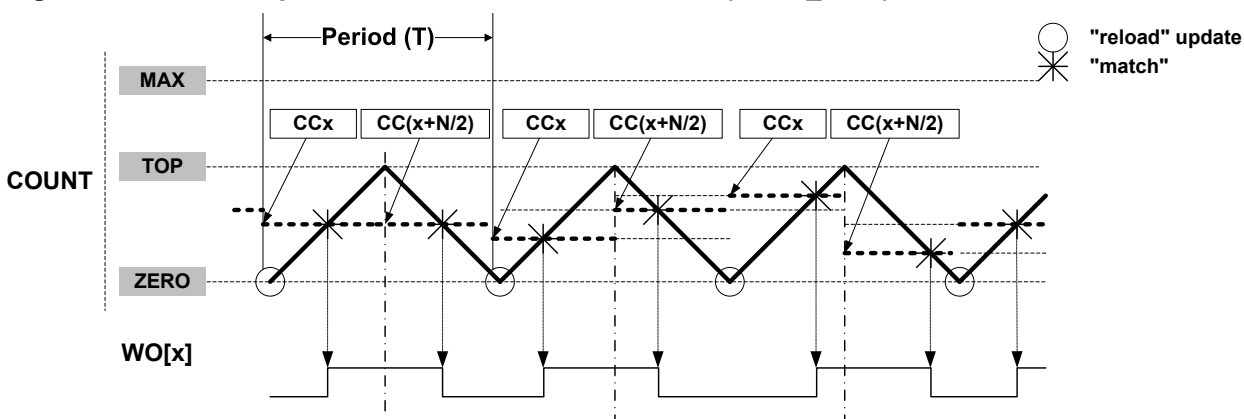
This bit selects whether even- and odd-numbered slots use separate DMA channels or the same DMA channel.

DMA	Name	Description
0x0	SINGLE	Single DMA channel
0x1	MULTIPLE	One DMA channel per data channel

Bit 24 – MONO: Mono Mode.

MONO	Name	Description
0x0	STEREO	Normal mode
0x1	MONO	Left channel data is duplicated to right channel

Figure 31-8. Dual-Slope Critical Pulse Width Modulation (N=CC_NUM)



Output Polarity

The polarity (WAVE.POLx) is available in all waveform output generation. In single-slope and dual-slope PWM operation, it is possible to invert the pulse edge alignment individually on start or end of a PWM cycle for each compare channels. The table below shows the waveform output set/clear conditions, depending on the settings of timer/counter, direction, and polarity.

Table 31-3. Waveform Generation Set/Clear Conditions

Waveform Generation operation	DIR	POLx	Waveform Generation Output Update	
			Set	Clear
Single-Slope PWM	0	0	Timer/counter matches TOP	Timer/counter matches CCx
		1	Timer/counter matches CC	Timer/counter matches TOP
	1	0	Timer/counter matches CC	Timer/counter matches ZERO
		1	Timer/counter matches ZERO	Timer/counter matches CC
Dual-Slope PWM	x	0	Timer/counter matches CC when counting up	Timer/counter matches CC when counting down
		1	Timer/counter matches CC when counting down	Timer/counter matches CC when counting up

In Normal and Match Frequency, the WAVE.POLx value represents the initial state of the waveform output.

31.6.2.6 Double Buffering

The Pattern (PATT), Waveform (WAVE), Period (PER) and Compare Channels (CCx) registers are all double buffered. Each buffer register has a buffer valid (PATTBV, WAVEBV, PERBV or CCBVx) bit in the STATUS register, which indicates that the buffer register contains a valid value that can be copied into the corresponding register. .

When the buffer valid flag bit in the STATUS register is '1' and the Lock Update bit in the CTRLB register is set to '0', (writing CTRLBCLR.LUPD to '1'), double buffering is enabled: the data from buffer registers will be copied into the corresponding register under hardware UPDATE conditions, then the buffer valid flags bit in the STATUS register are automatically cleared by hardware.

Note: Software update command (CTRLBSET.CMD=0x3) act independently of LUPD value.

A compare register is double buffered as in the following figure.

relative local Minimum (for CAPTMIN) or Maximum (for CAPTMAX) value has been detected. DERIV0 is equivalent to an OR function of (LOCMIN, LOCMAx).

In CAPT operation, capture is performed on each capture event. The MCx interrupt flag is set on each new capture.

In CAPTMIN and CAPTMAX operation, capture is performed only when on capture event time, the counter value is lower (for CAPTMIN) or upper (for CAPMAX) than the last captured value. The MCx interrupt flag is set only when on capture event time, the counter value is upper or equal (for CAPTMIN) or lower or equal (for CAPTMAX) to the value captured on the previous event. So interrupt flag is set when a new absolute local Minimum (for CAPTMIN) or Maximum (for CAPTMAX) value has been detected.

Interrupt Generation

In CAPT mode, an interrupt is generated on each filtered Fault n and each dedicated CCx channel capture counter value. In other modes, an interrupt is only generated on an extreme captured value.

Figure 31-26. Capture Action “CAPTMAX”

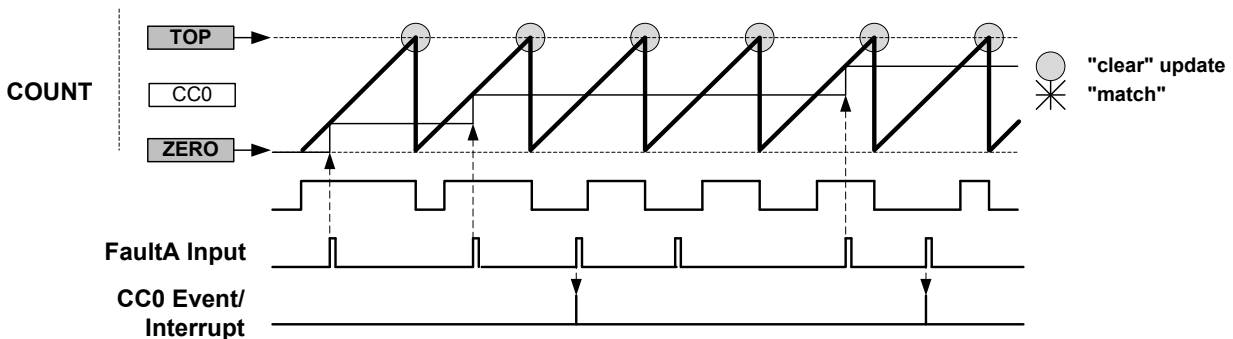
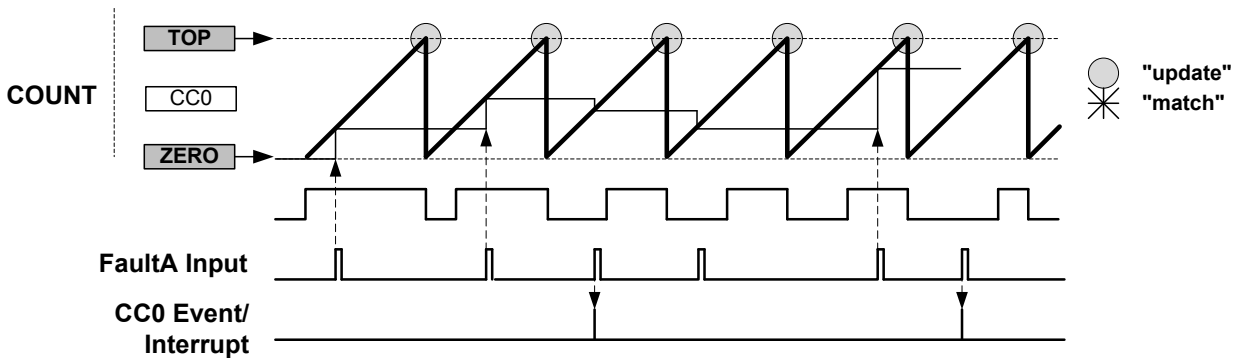


Figure 31-27. Capture Action “DERIV0”



Hardware Halt Action This is configured by writing 0x1 to the Fault n Halt mode bits in the Recoverable Fault n Configuration register (FCTRLn.HALT). When enabled, the timer/counter is halted and the cycle is extended as long as the corresponding fault is present.

The next figure ('Waveform Generation with Halt and Restart Actions') shows an example where both restart action and hardware halt action are enabled for Fault A. The compare channel 0 output is clamped to inactive level as long as the timer/counter is halted. The timer/counter resumes the counting operation as soon as the fault condition is no longer present. As the restart action is enabled in this example, the timer/counter is restarted after the fault condition is no longer present.

32-bit ARM-Based Microcontrollers

CTRLA.RESOLUTION	Bits [n:0]
0x2 - DITH5	4:0
0x3 - DITH6	5:0 (depicted)

31.8.18 Compare/Capture Channel x

The CCx register represents the 16-, 24- bit value, CCx. The register has two functions, depending of the mode of operation.

For capture operation, this register represents the second buffer level and access point for the CPU and DMA.

For compare operation, this register is continuously compared to the counter value. Normally, the output from the comparator is then used for generating waveforms.

CCx register is updated with the buffer value from their corresponding CCBx register when an UPDATE condition occurs.

In addition, in match frequency operation, the CC0 register controls the counter period.

Name: CCn

Offset: 0x44 + n*0x04 [n=0..3]

Reset: 0x00000000

Property: Write-Synchronized, Read-Synchronized

Bit	31	30	29	28	27	26	25	24
Access								
Reset								
Bit	23	22	21	20	19	18	17	16
	CC[17:10]							
Access	R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W
Reset	0	0	0	0	0	0	0	0
Bit	15	14	13	12	11	10	9	8
	CC[9:2]							
Access	R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W
Reset	0	0	0	0	0	0	0	0
Bit	7	6	5	4	3	2	1	0
	CC[1:0]		DITHER[5:0]					
Access	R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W
Reset	0	0	0	0	0	0	0	0

Bits 23:6 – CC[17:0]: Channel x Compare/Capture Value

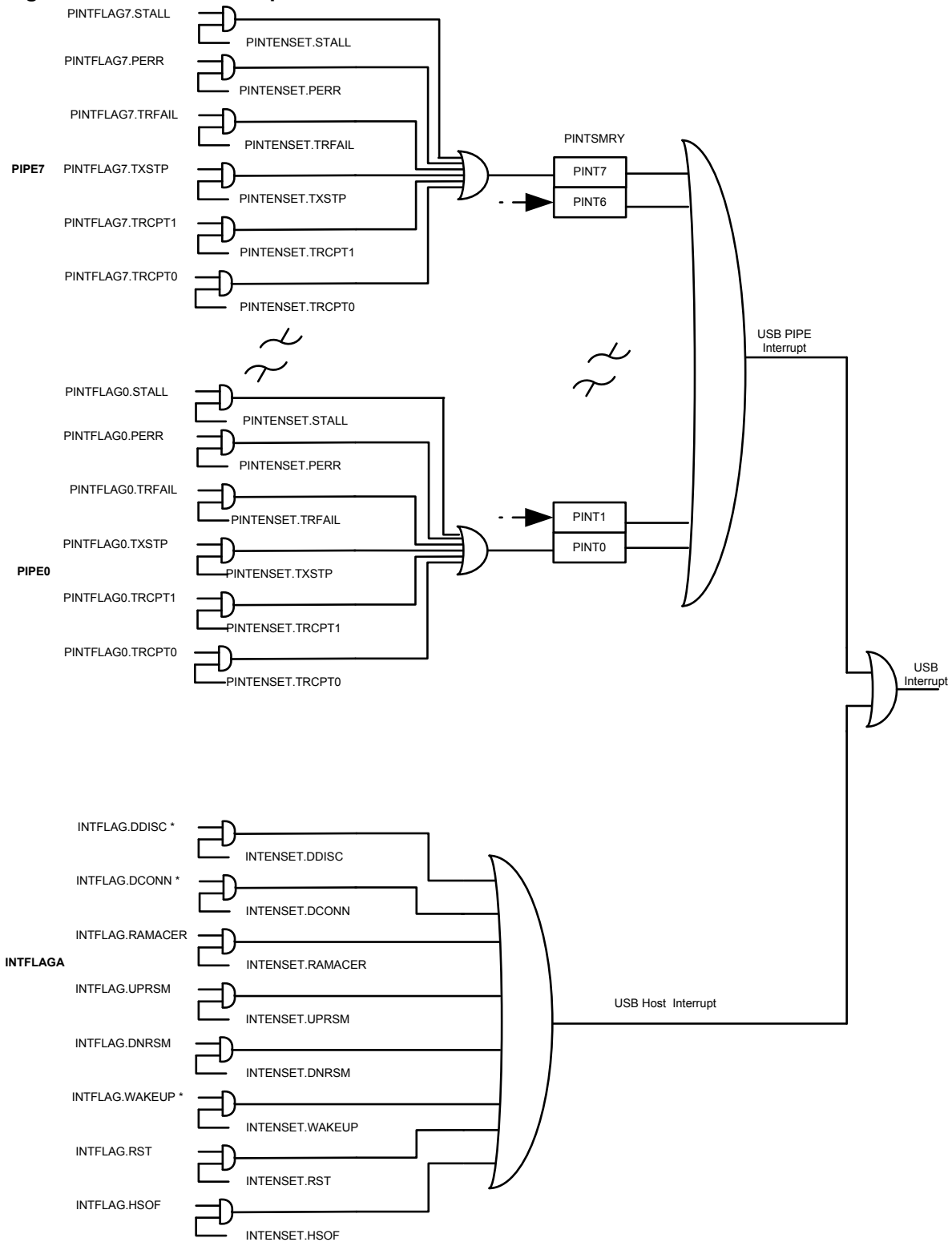
These bits hold the value of the Channel x compare/capture register.

Note: When the TCC is configured as 16-bit timer/counter, the excess bits are read zero.

Note: This bit field occupies the m MSB of the register, [23:m]. m is dependent on the Resolution bit in the Control A register (CTRLA.RESOLUTION):

32.6.3.17 Host Interrupt

Figure 32-10. Host Interrupt



* Asynchronous interrupt

The WAKEUP is an asynchronous interrupt and can be used to wake-up the device from any sleep mode.

Property: -

Bit	15	14	13	12	11	10	9	8
							LPMSUSP	LPMNYET
Access							R/W	R/W
Reset							0	0

Bit	7	6	5	4	3	2	1	0
	RAMACER	UPRSM	EORSM	WAKEUP	EORST	SOF		SUSPEND
Access	R/W	R/W	R/W	R/W	R/W	R/W		R/W
Reset	0	0	0	0	0	0		0

Bit 9 – LPMSUSP: Link Power Management Suspend Interrupt Flag

This flag is cleared by writing a one to the flag.

This flag is set when the USB module acknowledge a Link Power Management Transaction (ACK handshake) and has entered the Suspended state and will generate an interrupt if INTENCLR/SET.LPMSUSP is one.

Writing a zero to this bit has no effect.

Writing a one to this bit clears the LPMSUSP Interrupt Flag.

Bit 8 – LPMNYET: Link Power Management Not Yet Interrupt Flag

This flag is cleared by writing a one to the flag.

This flag is set when the USB module acknowledges a Link Power Management Transaction (handshake is NYET) and will generate an interrupt if INTENCLR/SET.LPMNYET is one.

Writing a zero to this bit has no effect.

Writing a one to this bit clears the LPMNYET Interrupt Flag.

Bit 7 – RAMACER: RAM Access Interrupt Flag

This flag is cleared by writing a one to the flag.

This flag is set when a RAM access underflow error occurs during IN data stage. This bit will generate an interrupt if INTENCLR/SET.RAMACER is one.

Writing a zero to this bit has no effect.

Bit 6 – UPRSM: Upstream Resume Interrupt Flag

This flag is cleared by writing a one to the flag.

This flag is set when the USB sends a resume signal called “Upstream Resume” and will generate an interrupt if INTENCLR/SET.UPRSM is one.

Writing a zero to this bit has no effect.

Bit 5 – EORSM: End Of Resume Interrupt Flag

This flag is cleared by writing a one to the flag.

This flag is set when the USB detects a valid “End of Resume” signal initiated by the host and will generate an interrupt if INTENCLR/SET.EORSM is one.

Writing a zero to this bit has no effect.

Bit 5 – STALL: Received Stall Interrupt Disable

Writing a zero to this bit has no effect.

Writing a one to this bit will clear the Received Stall interrupt Enable bit and disable the corresponding interrupt request.

Value	Description
0	The received Stall interrupt is disabled.
1	The received Stall interrupt is enabled and an interrupt request will be generated when the received Stall interrupt Flag is set.

Bit 4 – TXSTP: Transmitted Setup Interrupt Disable

Writing a zero to this bit has no effect.

Writing a one to this bit will clear the Transmitted Setup interrupt Enable bit and disable the corresponding interrupt request.

Value	Description
0	The Transmitted Setup interrupt is disabled.
1	The Transmitted Setup interrupt is enabled and an interrupt request will be generated when the Transmitted Setup interrupt Flag is set.

Bit 3 – PERR: Pipe Error Interrupt Disable

Writing a zero to this bit has no effect.

Writing a one to this bit will clear the Pipe Error interrupt Enable bit and disable the corresponding interrupt request.

Value	Description
0	The Pipe Error interrupt is disabled.
1	The Pipe Error interrupt is enabled and an interrupt request will be generated when the Pipe Error interrupt Flag is set.

Bit 2 – TRFAIL: Transfer Fail Interrupt Disable

Writing a zero to this bit has no effect.

Writing a one to this bit will clear the Transfer Fail interrupt Enable bit and disable the corresponding interrupt request.

Value	Description
0	The Transfer Fail interrupt is disabled.
1	The Transfer Fail interrupt is enabled and an interrupt request will be generated when the Transfer Fail interrupt Flag is set.

Bit 0 – TRCPT: Transfer Complete Bank x interrupt Disable

Writing a zero to this bit has no effect.

Writing a one to this bit will clear the Transfer Complete interrupt Enable bit x and disable the corresponding interrupt request.

Value	Description
0	The Transfer Complete Bank x interrupt is disabled.
1	The Transfer Complete Bank x interrupt is enabled and an interrupt request will be generated when the Transfer Complete interrupt x Flag is set.

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Table 37-57. FDPLL96M Characteristics⁽¹⁾ (Device Variant B / Die Revision E)

Symbol	Parameter	Conditions	Min.	Typ.	Max.	Units
f_{IN}	Input frequency		32	-	2000	KHz
f_{OUT}	Output frequency		48	-	96	MHz
$I_{FDPLL96M}$	Current consumption	$f_{IN}= 32\text{ kHz}, f_{OUT}= 48\text{ MHz}$	-	500	700	μA
		$f_{IN}= 32\text{ kHz}, f_{OUT}= 96\text{ MHz}$	-	900	1200	
J_p	Period jitter	$f_{IN}= 32\text{ kHz}, f_{OUT}= 48\text{ MHz}$	-	1.5	2.1	%
		$f_{IN}= 32\text{ kHz}, f_{OUT}= 96\text{ MHz}$	-	4.0	10.0	
		$f_{IN}= 2\text{ MHz}, f_{OUT}= 48\text{ MHz}$	-	1.6	2.2	
		$f_{IN}= 2\text{ MHz}, f_{OUT}= 96\text{ MHz}$	-	4.6	10.2	
t_{LOCK}	Lock Time	After start-up, time to get lock signal. $f_{IN}= 32\text{ kHz}, f_{OUT}= 96\text{ MHz}$	-	1.2	2	ms
		$f_{IN}= 2\text{ MHz}, f_{OUT}= 96\text{ MHz}$	-	25	50	μs
Duty	Duty cycle		40	50	60	%

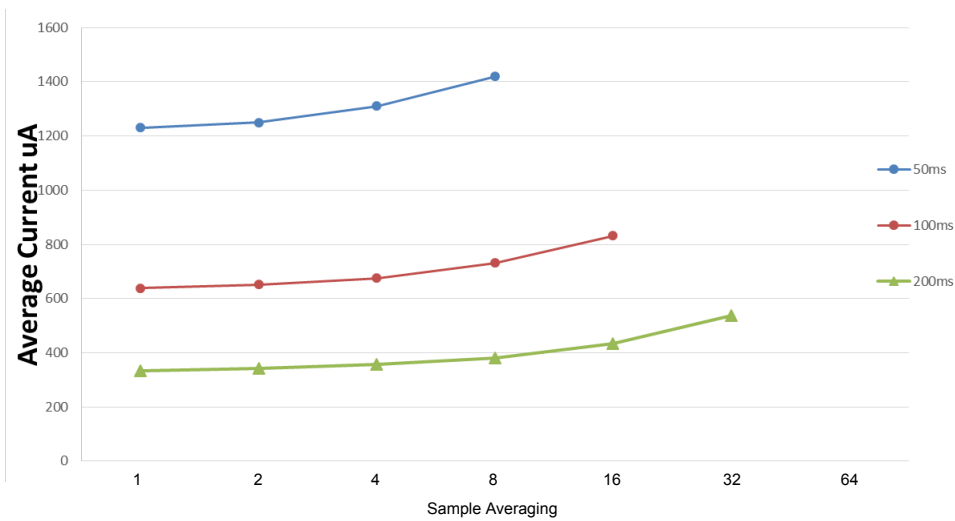
Table 37-58. FDPLL96M Characteristics⁽¹⁾ (Device Variant B and C / Die Revision F)

Symbol	Parameter	Conditions	Min.	Typ.	Max.	Units
f_{IN}	Input frequency		32	-	2000	KHz
f_{OUT}	Output frequency		48	-	96	MHz
$I_{FDPLL96M}$	Current consumption	$f_{IN}= 32\text{ kHz}, f_{OUT}= 48\text{ MHz}$	-	500	-	μA
		$f_{IN}= 32\text{ kHz}, f_{OUT}= 96\text{ MHz}$	-	900	-	
J_p	Period jitter	$f_{IN}= 32\text{ kHz}, f_{OUT}= 48\text{ MHz}$	-	2.2	3.0	%
		$f_{IN}= 32\text{ kHz}, f_{OUT}= 96\text{ MHz}$	-	3.7	9.0	
		$f_{IN}= 2\text{ MHz}, f_{OUT}= 48\text{ MHz}$	-	2.2	3.0	
		$f_{IN}= 2\text{ MHz}, f_{OUT}= 96\text{ MHz}$	-	4.4	9.7	
t_{LOCK}	Lock Time	After start-up, time to get lock signal. $f_{IN}= 32\text{ kHz}, f_{OUT}= 96\text{ MHz}$	-	1.0	2	ms
		$f_{IN}= 2\text{ MHz}, f_{OUT}= 96\text{ MHz}$	-	22	50	μs
Duty	Duty cycle		40	50	60	%

Note:

1. All values have been characterized with FILTSEL[1/0] as default value.

Figure 37-19. 100 Sensor / PTC_GCLK = 2MHz / FREQ_MODE_HOP



37.14 USB Characteristics

The USB on-chip buffers comply with the Universal Serial Bus (USB) v2.0 standard. All AC parameters related to these buffers can be found within the USB 2.0 electrical specifications.

The USB interface is USB-IF certified:

- TID 40001583 - Peripheral Silicon > Low/Full Speed > Silicon Building Blocks
- TID 120000272 - Embedded Hosts > Full Speed

Electrical configuration required to be USB compliance:

- The CPU frequency must be higher 8MHz when USB is active (No constraint for USB suspend mode)
- The operating voltages must be 3.3V (Min. 3.0V, Max. 3.6V).
- The GCLK_USB frequency accuracy source must be less than:
 - In USB device mode, 48MHz +/-0.25%
 - In USB host mode, 48MHz +/-0.05%

Table 37-59. GCLK_USB Clock Setup Recommendations

Clock setup		USB Device	USB Host
DFLL48M	Open loop	No	No
	Closed loop, any internal OSC source	No	No
	Closed loop, any external XOSC source	Yes	No
	Closed loop, USB SOF source (USB recovery mode) ⁽¹⁾	Yes ⁽²⁾	N/A
FDPLL96M	Any internal OSC source (32K, 8M, ...)	No	No
	Any external XOSC source (< 1MHz)	Yes	No
	Any external XOSC source (> 1MHz)	Yes ⁽³⁾	Yes

The SAM D21 oscillator is optimized for very low power consumption, hence close attention should be made when selecting crystals, see the table below for maximum ESR recommendations on 9pF and 12.5pF crystals.

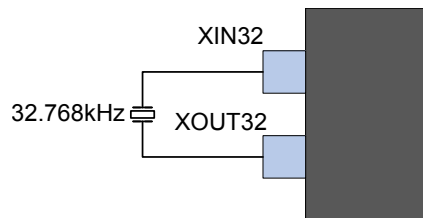
The Low-frequency Crystal Oscillator provides an internal load capacitance of typical values available in Table , *32kHz Crystal Oscillator Characteristics*. This internal load capacitance and PCB capacitance can allow to use a Crystal inferior to 12.5pF load capacitance without external capacitors as shown in the following figure.

Table 39-6. Maximum ESR Recommendation for 32.768kHz Crystal

Crystal C_L (pF)	Max ESR [k Ω]
12.5	313

Note: Maximum ESR is typical value based on characterization. These values are not covered by test limits in production.

Figure 39-7. External Real Time Oscillator without Load Capacitor



However, to improve Crystal accuracy and Safety Factor, it can be recommended by crystal datasheet to add external capacitors as shown in the next figure.

To find suitable load capacitance for a 32.768kHz crystal, consult the crystal datasheet.

Figure 39-8. External Real Time Oscillator with Load Capacitor

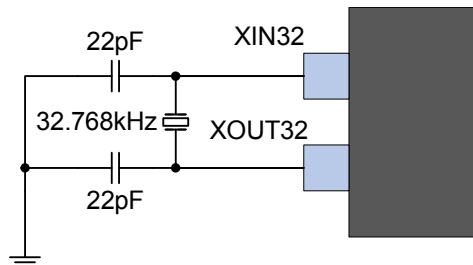


Table 39-7. External Real Time Oscillator Checklist

Signal Name	Recommended Pin Connection	Description
XIN32	Load capacitor 22pF ⁽¹⁾⁽²⁾	Timer oscillator input
XOUT32	Load capacitor 22pF ⁽¹⁾⁽²⁾	Timer oscillator output

1. These values are given only as typical examples.
2. Decoupling capacitor should be placed close to the device for each supply pin pair in the signal group.

Note: In order to minimize the cycle-to-cycle jitter of the external oscillator, keep the neighboring pins as steady as possible. For neighboring pin details, refer to the Oscillator Pinout section.

Related Links

Check that the lockbits: DFLLCKC and DFLLCKF in the SYSCTRL Interrupt Flag Status and Clear register (INTFLAG) are both set before enabling the DFLL00B interrupt.

40.1.4.5 XOSC32K

1 – The automatic amplitude control of the XOSC32K does not work.

Errata reference: 10933

Fix/Workaround:

Use the XOSC32K with Automatic Amplitude control disabled (XOSC32K.AAMPEN = 0)

40.1.4.6 FDPLL

1 – When changing on-the-fly the FDPLL ratio in DPLLnRATIO register, STATUS.DPLLnLDRT0 will not be set when the ratio update will be completed.

Errata reference: 15753

Fix/Workaround:

Wait for the interruption flag INTFLAG.DPLLnLDRT0 instead.

40.1.4.7 DMAC

1 – When at least one channel using linked descriptors is already active, enabling another DMA channel (with or without linked descriptors) can result in a channel Fetch Error (FERR) or an incorrect descriptor fetch.

This happens if the channel number of the channel being enabled is lower than the channel already active.

Errata reference: 15683

Fix/Workaround:

When enabling a DMA channel while other channels using linked descriptors are already active, the channel number of the new channel enabled must be greater than the other channel numbers.

2 – If data is written to CRCDATAIN in two consecutive instructions, the CRC computation may be incorrect.

Errata reference: 13507

Fix/Workaround:

Add a NOP instruction between each write to CRCDATAIN register.

40.1.4.8 EIC

1 – When the EIC is configured to generate an interrupt on a low level or rising edge or both edges (CONFIGn.SENSEx) with the filter enabled (CONFIGn.FILTENx), a spurious flag might appear for the dedicated pin on the INTFLAG.EXTINT[x] register as soon as the EIC is enabled using CTRLA ENABLE bit.

Errata reference: 15341

Fix/Workaround:

Clear the INTFLAG bit once the EIC enabled and before enabling the interrupts.

40.1.4.9 NVMCTRL

1 – Default value of MANW in NVM.CTRLB is 0.

Fix/Workaround:

Do not use the WCOMP interrupt. Use the WCOMP event.

40.2 Device Variant B

The device variant (last letter of the ordering number) is independent of the die revision (DSU.DID.REVISION): The device variant denotes functional differences, whereas the die revision marks evolution of the die.

40.2.1 Die Revision E

40.2.1.1 Device

1 – The SYSTICK calibration value is incorrect.**Errata reference: 14155****Fix/Workaround:**

The correct SYSTICK calibration value is 0x40000000. This value should not be used to initialize the SysTick RELOAD value register, which should be initialized instead with a value depending on the main clock frequency and on the tick period required by the application. For a detailed description of the SYSTICK module, refer to the official ARM Cortex-M0+ documentation.

2 – Pulldown functionality is not available on GPIO pin PA24 and PA25**Errata reference: 15051****Fix/Workaround:**

None

3 – The TCC interrupt flags

INTFLAG.ERR,INTFLAG.DFS,INTFLAG.UFS,INTFLAG.CNT, INTFLAG.FAULTA,INTFLAG.FAULTB, INTFLAG.FAULT0, INTFLAG.FAULT1 are not always properly set when using asynchronous TCC features.

Errata reference: 15179**Fix/Workaround:**

Do not use these flags when using asynchronous TCC features.

4 – On pin PA24 and PA25 the pull-up and pull-down configuration is not disabled automatically when alternative pin function is enabled except for USB.**Errata reference: 12368****Fix/Workaround:**

For pin PA24 and PA25, the GPIO pull-up and pull-down must be disabled before enabling alternative functions on them.

5 – If APB clock is stopped and GCLK clock is running, APB read access to read-synchronized registers will freeze the system. The CPU and the DAP AHB-AP are stalled, as a consequence debug operation is impossible.**Errata reference: 10416****Fix/Workaround:**

Do not make read access to read-synchronized registers when APB clock is stopped and GCLK is running. To recover from this situation, power cycle the device or reset the device using the RESETN pin.

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